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MAX2042A

SiGe High-Linearity, 1600MHz to 3900MHz Upconversion/Downconversion Mixer with LO Buffer

General Description

The MAX2042A single, high-linearity upconversion/downconversion mixer provides up to +33dBm input IP3, 7.25dB noise figure, and 7.2dB conversion loss for 1600MHz to 3900MHz GSM/EDGE, CDMA, TD-SCDMA, WCDMA, LTE, TD-LTE, WiMAX™, and MMDS wireless infrastructure applications. With an ultra-wide 1300MHz to 4000MHz LO frequency range, the IC can be used in either low-side or high-side LO injection architectures for virtually all 1.7GHz to 3.5GHz applications (for a 2.5GHz variant tuned specifically for low-side LO injection, refer to the MAX2042).

In addition to offering excellent linearity and noise performance, the IC also yields a high level of component integration. This device includes a double-balanced passive mixer core, an LO buffer, and on-chip baluns that allow for single-ended RF and LO inputs. The IC requires a nominal LO drive of 0dBm, and supply current is typically 140mA at $V_{CC} = 5.0V$ or 122mA at $V_{CC} = 3.3V$.

The MAX2042A is pin compatible with the MAX2042 2000MHz to 3000MHz mixer. The MAX2042A is also pin similar with the MAX2029/MAX2031/MAX2033 650MHz to 1550MHz mixers, the MAX2039/MAX2041 1700MHz to 3000MHz mixers, and the MAX2044 2300MHz to 4000MHz mixer, making the entire family of upconverters/downconverters ideal for applications where a common PCB layout is used for multiple frequency bands.

The MAX2042A is available in a compact, 20-pin TQFN package (5mm x 5mm) with an exposed pad. Electrical performance is guaranteed over the extended $T_C = -40^{\circ}C$ to $+85^{\circ}C$ temperature range.

Applications

- 1.8GHz/1.9GHz GSM/EDGE/CDMA Base Stations
- 2.1GHz WCDMA/LTE Base Stations
- 2.3GHz TD-SCDMA/TD-LTE Base Stations
- 2.5GHz WiMAX and LTE Base Stations
- 2.7GHz MMDS Base Stations
- 3.5GHz WiMAX and LTE Base Stations
- Fixed Broadband Wireless Access
- Wireless Local Loop
- Private Mobile Radios
- Military Systems

Benefits and Features

- ◆ **Wide-Band Coverage**
 - ◇ 1600MHz to 3900MHz RF Frequency Range
 - ◇ 1300MHz to 4000MHz LO Frequency Range
 - ◇ 50MHz to 500MHz IF Frequency Range
- ◆ **7.2dB Conversion Loss**
- ◆ **7.25dB Noise Figure**
- ◆ **High Linearity**
 - ◇ +33dBm Input IP3
 - ◇ +21.7dBm Input 1dB Compression Point
 - ◇ 72dBc Typical 2LO - 2RF Spurious Rejection at $P_{RF} = -10dBm$
- ◆ **Simple PCB Layout**
 - ◇ Integrated LO Buffer
 - ◇ Integrated LO and RF Baluns for Single-Ended Inputs
- ◆ **Low -6dBm to +3dBm LO Drive**
- ◆ **Pin Compatible with the MAX2042 2000MHz to 3000MHz Mixer**
- ◆ **Pin-Similar with the MAX2029/MAX2031/MAX2033 650MHz to 1550MHz Mixers, MAX2039/MAX2041 1700MHz to 3000MHz Mixers, and MAX2044 2300MHz to 4000MHz Mixer**
- ◆ **Single +5.0V or +3.3V Supply**
- ◆ **External Current-Setting Resistor Provides Option for Operating Device in Reduced-Power/Reduced-Performance Mode**

[Ordering Information](#) appears at end of data sheet.

For related parts and recommended products to use with this part, refer to www.maxim-ic.com/MAX2042A.related.

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SiGe High-Linearity, 1600MHz to 3900MHz Upconversion/Downconversion Mixer with LO Buffer

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Upconversion/Downconversion Mixer with LO Buffer**

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ABSOLUTE MAXIMUM RATINGS

| | | | |
|---|-----------------------------------|--|-----------------|
| V _{CC} to GND..... | -0.3V to +5.5V | Operating Case Temperature Range (Note 1)..... | -40°C to +85°C |
| IF+, IF-, LOBIAS to GND | -0.3V to (V _{CC} + 0.3V) | Continuous Power Dissipation (Note 2) | 5.0W |
| RF, LO Input Power..... | +20dBm | Junction Temperature | +150°C |
| IF Input Power (50Ω source)..... | +18dBm | Storage Temperature Range..... | -65°C to +150°C |
| RF, LO Current (RF and LO are DC shorted to GND through a balun)..... | 50mA | Lead Temperature (soldering 10s) | +300°C |
| | | Soldering Temperature (reflow) | +260°C |

Note 1: T_C is the temperature on the exposed pad of the package. T_A is the ambient temperature of the device and PCB.

Note 2: Based on junction temperature T_J = T_C + (θ_{JC} × V_{CC} × I_{CC}). This formula can be used when the temperature of the exposed pad is known while the device is soldered down to a PCB. See the [Applications Information](#) section for details. The junction temperature must not exceed +150°C.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

PACKAGE THERMAL CHARACTERISTICS

TQFN

| | |
|--|--|
| Junction-to-Ambient | Junction-to-Case |
| Thermal Resistance θ _{JA} (Notes 3, 4)..... | Thermal Resistance θ _{JC} (Notes 2, 4)..... |
| +38°C/W | +13°C/W |

Note 3: Junction temperature T_J = T_A + (θ_{JA} × V_{CC} × I_{CC}). This formula can be used when the ambient temperature of the PCB is known. The junction temperature must not exceed +150°C.

Note 4: Package thermal resistances were obtained using the method described in JEDEC specification JESD51-7, using a four-layer board. For detailed information on package thermal considerations, refer to www.maxim-ic.com/thermal-tutorial.

5.0V SUPPLY DC ELECTRICAL CHARACTERISTICS

(*Typical Application Circuit*, V_{CC} = 4.75V to 5.25V, no input AC signals. T_C = -40°C to +85°C, unless otherwise noted. Typical values are at V_{CC} = 5.0V, T_C = +25°C.)

| PARAMETER | SYMBOL | CONDITIONS | MIN | TYP | MAX | UNITS |
|----------------|-----------------|------------|------|-----|------|-------|
| Supply Voltage | V _{CC} | | 4.75 | 5 | 5.25 | V |
| Supply Current | I _{CC} | | | 140 | 162 | mA |

3.3V SUPPLY DC ELECTRICAL CHARACTERISTICS

(*Typical Application Circuit*, V_{CC} = 3.0V to 3.6V, no input AC applied. T_C = -40°C to +85°C, unless otherwise noted. Typical values are at V_{CC} = 3.3V, T_C = +25°C.)

| PARAMETER | SYMBOL | CONDITIONS | MIN | TYP | MAX | UNITS |
|----------------|-----------------|------------|-----|-----|-----|-------|
| Supply Voltage | V _{CC} | | 3.0 | 3.3 | 3.6 | V |
| Supply Current | I _{CC} | | | 122 | | mA |

SiGe High-Linearity, 1600MHz to 3900MHz Upconversion/Downconversion Mixer with LO Buffer

RECOMMENDED AC OPERATING CONDITIONS

| PARAMETER | SYMBOL | CONDITIONS | MIN | TYP | MAX | UNITS |
|--|-----------|---|------|-----|------|-------|
| RF Frequency Range Without Tuning | f_{RF1} | Typical Application Circuit with $C1 = 8.2\text{pF}$ (Table 1) (Notes 5, 6) | 2000 | | 2900 | MHz |
| RF Frequency Range With Low-Band Tuning | f_{RF2} | Typical Application Circuit with $C1 = 1.8\text{pF}$, $L1 = 12\text{nH}$ (Table 1) (Notes 5, 6) | 1600 | | 2000 | MHz |
| RF Frequency Range With High-Band Tuning | f_{RF3} | Typical Application Circuit with $C1 = 1.5\text{pF}$ (Table 1) (Notes 5, 6) | 3000 | | 3900 | MHz |
| LO Frequency | f_{LO} | (Note 5, 6) | 1300 | | 4000 | MHz |
| IF Frequency | f_{IF} | Using M/A-Com MABACT0069 1:1 transformer as defined in the Typical Application Circuit, IF matching components affect the IF frequency range (Notes 5, 6) | 50 | | 500 | MHz |
| LO Drive | P_{LO} | | -6 | 0 | +3 | dBm |

5.0V Supply, RF = 2000MHz to 2900MHz, HIGH-SIDE LO INJECTION AC ELECTRICAL CHARACTERISTICS (DOWNCONVERTER OPERATION)

(Typical Application Circuit with tuning elements outlined in Table 1, $V_{CC} = 4.75\text{V}$ to 5.25V , RF and LO ports are driven from 50Ω sources, $P_{LO} = -6\text{dBm}$ to $+3\text{dBm}$, $P_{RF} = 0\text{dBm}$, $f_{RF} = 2000\text{MHz}$ to 2900MHz , $f_{LO} = 2300\text{MHz}$ to 3200MHz , $f_{IF} = 300\text{MHz}$, $f_{RF} < f_{LO}$, $T_C = -40^\circ\text{C}$ to $+85^\circ\text{C}$. Typical values are for $T_C = +25^\circ\text{C}$, $V_{CC} = 5.0\text{V}$, $P_{LO} = 0\text{dBm}$, $f_{RF} = 2600\text{MHz}$, $f_{LO} = 2900\text{MHz}$, $f_{IF} = 300\text{MHz}$.) (Note 7)

| PARAMETER | SYMBOL | CONDITIONS | MIN | TYP | MAX | UNITS |
|---|-----------------|--|-----|------------|-----|----------------------|
| Small-Signal Conversion Loss | L_C | $f_{RF} = 2600\text{MHz}$, $f_{LO} = 2900\text{MHz}$ | | 7.2 | | |
| | | $f_{RF} = 2900\text{MHz}$, $f_{LO} = 3200\text{MHz}$ (Note 8) | | 7.8 | | |
| Loss Variation vs. Frequency | ΔL_C | $f_{RF} = 2010\text{MHz}$ to 2025MHz | | ± 0.05 | | dB |
| | | $f_{RF} = 2305\text{MHz}$ to 2360MHz | | ± 0.05 | | dB |
| | | $f_{RF} = 2500\text{MHz}$ to 2570MHz | | ± 0.05 | | dB |
| | | $f_{RF} = 2570\text{MHz}$ to 2620MHz | | ± 0.05 | | dB |
| | | $f_{RF} = 2500\text{MHz}$ to 2690MHz | | ± 0.13 | | dB |
| | | $f_{RF} = 2700\text{MHz}$ to 2900MHz | | ± 0.02 | | dB |
| Conversion Loss Temperature Coefficient | TC_{CL} | $T_C = -40^\circ\text{C}$ to $+85^\circ\text{C}$ | | 0.007 | | dB/ $^\circ\text{C}$ |
| Single Sideband Noise Figure | NF_{SSB} | No blockers present | | 7.25 | | dB |
| Noise Figure Temperature Coefficient | TC_{NF} | $f_{RF} = 2600\text{MHz}$, single sideband, no blockers present, $T_C = -40^\circ\text{C}$ to $+85^\circ\text{C}$ | | 0.022 | | dB/ $^\circ\text{C}$ |
| Noise Figure Under Blocking | $NF_{Blocking}$ | +8dBm blocker tone applied to RF port, $f_{RF} = 2600\text{MHz}$, $f_{LO} = 2900\text{MHz}$, $f_{BLOCKER} = 2400\text{MHz}$ (Note 9) | | 18 | | dB |

SiGe High-Linearity, 1600MHz to 3900MHz Upconversion/Downconversion Mixer with LO Buffer

5.0V Supply, RF = 2000MHz to 2900MHz, HIGH-SIDE LO INJECTION AC ELECTRICAL CHARACTERISTICS (DOWNCONVERTER OPERATION) (continued)

(*Typical Application Circuit* with tuning elements outlined in [Table 1](#), $V_{CC} = 4.75V$ to $5.25V$, RF and LO ports are driven from 50Ω sources, $P_{LO} = -6dBm$ to $+3dBm$, $P_{RF} = 0dBm$, $f_{RF} = 2000MHz$ to $2900MHz$, $f_{LO} = 2300MHz$ to $3200MHz$, $f_{IF} = 300MHz$, $f_{RF} < f_{LO}$, $T_C = -40^\circ C$ to $+85^\circ C$. Typical values are for $T_C = +25^\circ C$, $V_{CC} = 5.0V$, $P_{LO} = 0dBm$, $f_{RF} = 2600MHz$, $f_{LO} = 2900MHz$, $f_{IF} = 300MHz$.) (Note 7)

| PARAMETER | SYMBOL | CONDITIONS | MIN | TYP | MAX | UNITS |
|-----------------------------------|------------|---|-------------------|-----------|-----|----------|
| Input 1dB Compression Point | IP_{1dB} | (Note 10) | | 21.7 | | dBm |
| Third-Order Input Intercept Point | IIP3 | $f_{RF1} - f_{RF2} = 1MHz$, $P_{RF1} = P_{RF2} = 0dBm$ (Note 8) | | 33 | | dBm |
| IIP3 Variation with T_C | | $f_{RF1} - f_{RF2} = 1MHz$, $P_{RF1} = P_{RF2} = 0dBm$, $T_C = -40^\circ C$ to $+85^\circ C$ | | ± 0.3 | | dB |
| 2LO - 2RF Spur Rejection | 2 x 2 | $f_{RF} = 2600MHz$, $f_{LO} = 2900MHz$, $f_{SPUR} = 2750MHz$ | $P_{RF} = -10dBm$ | 72 | | dBc |
| | | | $P_{RF} = 0dBm$ | 62 | | |
| 3LO - 3RF Spur Rejection | 3 x 3 | $f_{RF} = 2600MHz$, $f_{LO} = 2900MHz$, $f_{SPUR} = 2800MHz$ | $P_{RF} = -10dBm$ | 91 | | dBc |
| | | | $P_{RF} = 0dBm$ | 71 | | |
| RF Input Return Loss | RL_{RF} | LO on and IF terminated into a matched impedance | | 20 | | dB |
| LO Input Return Loss | RL_{LO} | RF and IF terminated into a matched impedance | | 19 | | dB |
| IF Output Impedance | Z_{IF} | Nominal differential impedance at the IC's IF outputs | | 50 | | Ω |
| IF Return Loss | RL_{IF} | RF terminated into 50Ω , LO driven by 50Ω source, IF transformed to single-ended 50Ω using external components shown in the <i>Typical Application Circuit</i> | | 17.5 | | dB |
| RF-to-IF Isolation | | $P_{LO} = +3dBm$ (Note 8) | | 38 | | dB |
| LO Leakage at RF Port | | $P_{LO} = +3dBm$ (Note 8) | | -29 | | dBm |
| 2LO Leakage at RF Port | | $P_{LO} = +3dBm$ | | -30.1 | | dBm |
| LO Leakage at IF Port | | $P_{LO} = +3dBm$ (Note 8) | | -31 | | dBm |

SiGe High-Linearity, 1600MHz to 3900MHz Upconversion/Downconversion Mixer with LO Buffer

3.3V Supply, RF = 2000MHz to 2900MHz, HIGH-SIDE LO INJECTION AC ELECTRICAL CHARACTERISTICS (DOWNCONVERTER OPERATION)

(*Typical Application Circuit* with tuning elements outlined in [Table 1](#), RF and LO ports are driven from 50Ω sources, Typical values are for $T_C = +25^\circ\text{C}$, $V_{CC} = 3.3\text{V}$, $P_{RF} = 0\text{dBm}$, $P_{LO} = 0\text{dBm}$, $f_{RF} = 2600\text{MHz}$, $f_{LO} = 2900\text{MHz}$, $f_{IF} = 300\text{MHz}$, unless otherwise noted.)

| PARAMETER | SYMBOL | CONDITIONS | MIN | TYP | MAX | UNITS |
|---|--------------|---|--------------------------|------------|-----|-------|
| Small-Signal Conversion Loss | L_C | (Note 8) | | 7.4 | | dB |
| Loss Variation vs. Frequency | ΔL_C | $f_{RF} = 2000\text{MHz}$ to 2900MHz , any 100MHz band | | ± 0.25 | | dB |
| Conversion Loss Temperature Coefficient | TC_{CL} | $T_C = -40^\circ\text{C}$ to $+85^\circ\text{C}$ | | 0.0079 | | dB/°C |
| Single Sideband Noise Figure | NF_{SSB} | No blockers present | | 7.4 | | dB |
| Noise Figure Temperature Coefficient | TC_{NF} | Single sideband, no blockers present, $T_C = -40^\circ\text{C}$ to $+85^\circ\text{C}$ | | 0.022 | | dB/°C |
| Input 1dB Compression Point | IP_{1dB} | (Note 10) | | 19.7 | | dBm |
| Third-Order Input Intercept Point | IIP3 | $f_{RF1} = 2600\text{MHz}$, $f_{RF2} = 2601\text{MHz}$, $P_{RF1} = P_{RF2} = 0\text{dBm}$ | | 31 | | dBm |
| IIP3 Variation with T_C | | $f_{RF1} = 2600\text{MHz}$, $f_{RF2} = 2601\text{MHz}$, $P_{RF1} = P_{RF2} = 0\text{dBm}$, $T_C = -40^\circ\text{C}$ to $+85^\circ\text{C}$ | | ± 0.1 | | dB |
| 2LO - 2RF Spur Rejection | 2 x 2 | $f_{RF} = 2600\text{MHz}$, $f_{LO} = 2900\text{MHz}$, $f_{SPUR} = 2750\text{MHz}$ | $P_{RF} = -10\text{dBm}$ | 72 | | dBc |
| | | | $P_{RF} = 0\text{dBm}$ | 62 | | |
| 3LO - 3RF Spur Rejection | 3 x 3 | $f_{RF} = 2600\text{MHz}$, $f_{LO} = 2900\text{MHz}$, $f_{SPUR} = 2800\text{MHz}$ | $P_{RF} = -10\text{dBm}$ | 85 | | dBc |
| | | | $P_{RF} = 0\text{dBm}$ | 65 | | |
| RF Input Return Loss | RL_{RF} | LO on and IF terminated into a matched impedance | | 16 | | dB |
| LO Input Return Loss | RL_{LO} | RF and IF terminated into a matched impedance | | 32 | | dB |
| IF Output Impedance | Z_{IF} | Nominal differential impedance at the IC's IF outputs | | 50 | | Ω |
| IF Return Loss | RL_{IF} | RF terminated into 50Ω, LO driven by 50Ω source, IF transformed to single-ended 50Ω using external components shown in the <i>Typical Application Circuit</i> | | 18 | | dB |
| RF-to-IF Isolation | | $P_{LO} = +3\text{dBm}$ | | 38 | | dB |
| LO Leakage at RF Port | | $P_{LO} = +3\text{dBm}$ | | -31.5 | | dBm |
| 2LO Leakage at RF Port | | $P_{LO} = +3\text{dBm}$ | | -30 | | dBm |
| LO Leakage at IF Port | | $P_{LO} = +3\text{dBm}$ | | -31.4 | | dBm |

SiGe High-Linearity, 1600MHz to 3900MHz Upconversion/Downconversion Mixer with LO Buffer

5.0V Supply, RF = 3100MHz to 3900MHz, LOW-SIDE LO INJECTION AC ELECTRICAL CHARACTERISTICS (DOWNCONVERTER OPERATION)

(*Typical Application Circuit* with tuning elements outlined in [Table 1](#). Typical values are for $T_C = +25^\circ\text{C}$, $V_{CC} = 5.0\text{V}$, $P_{RF} = 0\text{dBm}$, $P_{LO} = 0\text{dBm}$, $f_{RF} = 3500\text{MHz}$, $f_{LO} = 3200\text{MHz}$, $f_{IF} = 300\text{MHz}$, unless otherwise noted.)

| PARAMETER | SYMBOL | CONDITIONS | MIN | TYP | MAX | UNITS |
|---|--------------|---|--------------------------|-------------|-----|----------------------|
| Small-Signal Conversion Loss | L_C | | | 8.2 | | dB |
| Loss Variation vs. Frequency | ΔL_C | $f_{RF} = 3450\text{MHz}$ to 3750MHz , any 100MHz band | | ± 0.085 | | dB |
| | | $f_{RF} = 3450\text{MHz}$ to 3750MHz , any 200MHz band | | ± 0.17 | | dB |
| Conversion Loss Temperature Coefficient | TC_{CL} | $T_C = -40^\circ\text{C}$ to $+85^\circ\text{C}$ | | 0.0091 | | dB/ $^\circ\text{C}$ |
| Single Sideband Noise Figure | NF_{SSB} | No blockers present | | 7.6 | | dB |
| Noise Figure Temperature Coefficient | TC_{NF} | Single sideband, no blockers present, $T_C = -40^\circ\text{C}$ to $+85^\circ\text{C}$ | | 0.025 | | dB/ $^\circ\text{C}$ |
| Input 1dB Compression Point | IP_{1dB} | (Note 10) | | 20.6 | | dBm |
| Third-Order Input Intercept Point | IIP3 | $f_{RF1} - f_{RF2} = 1\text{MHz}$, $P_{RF1} = P_{RF2} = 0\text{dBm}$ | | 31 | | dBm |
| IIP3 Variation with T_C | | $f_{RF1} - f_{RF2} = 1\text{MHz}$, $P_{RF1} = P_{RF2} = 0\text{dBm}$, $T_C = -40^\circ\text{C}$ to $+85^\circ\text{C}$ | | ± 0.5 | | dB |
| 2RF - 2LO Spur Rejection | 2 x 2 | $f_{RF} = 3500\text{MHz}$, $f_{LO} = 3200\text{MHz}$, $f_{SPUR} = 3350\text{MHz}$ | $P_{RF} = -10\text{dBm}$ | 71 | | dBc |
| | | | $P_{RF} = 0\text{dBm}$ | 61 | | |
| 3RF - 3LO Spur Rejection | 3 x 3 | $f_{RF} = 3500\text{MHz}$, $f_{LO} = 3200\text{MHz}$, $f_{SPUR} = 3300\text{MHz}$ | $P_{RF} = -10\text{dBm}$ | 87 | | dBc |
| | | | $P_{RF} = 0\text{dBm}$ | 67 | | |
| RF Input Return Loss | RL_{RF} | LO on and IF terminated into a matched impedance | | 15 | | dB |
| LO Input Return Loss | RL_{LO} | RF and IF terminated into a matched impedance | | 20 | | dB |
| IF Output Impedance | Z_{IF} | Nominal differential impedance at the IC's IF outputs | | 50 | | Ω |
| IF Return Loss | RL_{IF} | RF terminated into 50Ω , LO driven by 50Ω source, IF transformed to single-ended 50Ω using external components shown in the <i>Typical Application Circuit</i> | | 16.5 | | dB |
| RF-to-IF Isolation | | $P_{LO} = +3\text{dBm}$ | | 35 | | dB |
| LO Leakage at RF Port | | $P_{LO} = +3\text{dBm}$ | | -29.5 | | dBm |
| 2LO Leakage at RF Port | | $P_{LO} = +3\text{dBm}$ | | -23 | | dBm |
| LO Leakage at IF Port | | $P_{LO} = +3\text{dBm}$ | | -31.5 | | dBm |

SiGe High-Linearity, 1600MHz to 3900MHz Upconversion/Downconversion Mixer with LO Buffer

5.0V Supply, RF = 3100MHz to 3900MHz, HIGH-SIDE LO INJECTION AC ELECTRICAL CHARACTERISTICS (DOWNCONVERTER OPERATION)

(*Typical Application Circuit* with tuning elements outlined in [Table 1](#). Typical values are for $T_C = +25^\circ\text{C}$, $V_{CC} = 5.0\text{V}$, $P_{RF} = 0\text{dBm}$, $P_{LO} = 0\text{dBm}$, $f_{RF} = 3500\text{MHz}$, $f_{LO} = 3800\text{MHz}$, $f_{IF} = 300\text{MHz}$, unless otherwise noted.)

| PARAMETER | SYMBOL | CONDITIONS | MIN | TYP | MAX | UNITS |
|---|--------------|---|--------------------------|-----------|-----|----------------------|
| Small-Signal Conversion Loss | L_C | | | 8.6 | | dB |
| Loss Variation vs. Frequency | ΔL_C | $f_{RF} = 3450\text{MHz}$ to 3750MHz , any 100MHz band | | ± 0.1 | | dB |
| | | $f_{RF} = 3450\text{MHz}$ to 3750MHz , any 200MHz band | | ± 0.2 | | dB |
| Conversion Loss Temperature Coefficient | TC_{CL} | $T_C = -40^\circ\text{C}$ to $+85^\circ\text{C}$ | | 0.01 | | dB/ $^\circ\text{C}$ |
| Single Sideband Noise Figure | NF_{SSB} | No blockers present | | 9 | | dB |
| Noise Figure Temperature Coefficient | TC_{NF} | Single sideband, no blockers present, $T_C = -40^\circ\text{C}$ to $+85^\circ\text{C}$ | | 0.025 | | dB/ $^\circ\text{C}$ |
| Input 1dB Compression Point | IP_{1dB} | (Note 10) | | 18 | | dBm |
| Third-Order Input Intercept Point | $IIP3$ | $f_{RF1} = 3500\text{MHz}$, $f_{RF2} = 3501\text{MHz}$, $P_{RF1} = P_{RF2} = 0\text{dBm}$ | | 28.6 | | dBm |
| IIP3 Variation with T_C | | $f_{RF1} = 3500\text{MHz}$, $f_{RF2} = 3501\text{MHz}$, $P_{RF1} = P_{RF2} = 0\text{dBm}$, $T_C = -40^\circ\text{C}$ to $+85^\circ\text{C}$ | | ± 0.5 | | dB |
| 2LO - 2RF Spur Rejection | 2×2 | $f_{RF} = 3500\text{MHz}$, $f_{LO} = 3800\text{MHz}$, $f_{SPUR} = 3650\text{MHz}$ | $P_{RF} = -10\text{dBm}$ | 70 | | dBc |
| | | | $P_{RF} = 0\text{dBm}$ | 60 | | |
| 3LO - 3RF Spur Rejection | 3×3 | $f_{RF} = 3500\text{MHz}$, $f_{LO} = 3800\text{MHz}$, $f_{SPUR} = 3700\text{MHz}$ | $P_{RF} = -10\text{dBm}$ | 83 | | dBc |
| | | | $P_{RF} = 0\text{dBm}$ | 63 | | |
| RF Input Return Loss | RL_{RF} | LO on and IF terminated into a matched impedance | | 15.5 | | dB |
| LO Input Return Loss | RL_{LO} | RF and IF terminated into a matched impedance | | 18.5 | | dB |
| IF Output Impedance | Z_{IF} | Nominal differential impedance at the IC's IF outputs | | 50 | | Ω |
| IF Return Loss | RL_{IF} | RF terminated into 50Ω , LO driven by 50Ω source, IF transformed to single-ended 50Ω using external components shown in the <i>Typical Application Circuit</i> | | 16 | | dB |
| RF-to-IF Isolation | | $P_{LO} = +3\text{dBm}$ | | 35 | | dB |
| LO Leakage at RF Port | | $P_{LO} = +3\text{dBm}$ | | -36.4 | | dBm |
| 2LO Leakage at RF Port | | $P_{LO} = +3\text{dBm}$ | | -12.8 | | dBm |
| LO Leakage at IF Port | | $P_{LO} = +3\text{dBm}$ | | -31 | | dBm |

SiGe High-Linearity, 1600MHz to 3900MHz Upconversion/Downconversion Mixer with LO Buffer

5.0V Supply, RF = 1650MHz to 2250MHz, HIGH-SIDE LO INJECTION AC ELECTRICAL CHARACTERISTICS (DOWNCONVERTER OPERATION)

(*Typical Application Circuit* with tuning elements outlined in [Table 1](#). Typical values are for $T_C = +25^\circ\text{C}$, $V_{CC} = 5.0\text{V}$, $P_{RF} = 0\text{dBm}$, $P_{LO} = 0\text{dBm}$, $f_{RF} = 1850\text{MHz}$, $f_{LO} = 2150\text{MHz}$, $f_{IF} = 300\text{MHz}$, unless otherwise noted.)

| PARAMETER | SYMBOL | CONDITIONS | MIN | TYP | MAX | UNITS |
|---|--------------|---|--------------------------|------------|-----|----------------------|
| Small-Signal Conversion Loss | L_C | | | 7.5 | | dB |
| Loss Variation vs. Frequency | ΔL_C | $f_{RF} = 1650\text{MHz}$ to 1850MHz , any 100MHz band | | ± 0.18 | | dB |
| | | $f_{RF} = 1850\text{MHz}$ to 2250MHz , any 100MHz band | | ± 0.15 | | |
| | | $f_{RF} = 1650\text{MHz}$ to 1850MHz , any 200MHz band | | ± 0.36 | | |
| | | $f_{RF} = 1850\text{MHz}$ to 2250MHz , any 200MHz band | | ± 0.3 | | |
| Conversion Loss Temperature Coefficient | TC_{CL} | $T_C = -40^\circ\text{C}$ to $+85^\circ\text{C}$ | | 0.0067 | | dB/ $^\circ\text{C}$ |
| Single Sideband Noise Figure | NF_{SSB} | No blockers present | | 7 | | dB |
| Noise Figure Temperature Coefficient | TC_{NF} | Single sideband, no blockers present, $T_C = -40^\circ\text{C}$ to $+85^\circ\text{C}$ | | 0.021 | | dB/ $^\circ\text{C}$ |
| Input 1dB Compression Point | IP_{1dB} | (Note 10) | | 23 | | dBm |
| Third-Order Input Intercept Point | IIP3 | $f_{RF1} = 1850\text{MHz}$, $f_{RF2} = 1851\text{MHz}$, $P_{RF1} = P_{RF2} = 0\text{dBm}$ | | 34.8 | | dBm |
| IIP3 Variation with T_C | | $f_{RF1} = 1850\text{MHz}$, $f_{RF2} = 1851\text{MHz}$, $P_{RF1} = P_{RF2} = 0\text{dBm}$, $T_C = -40^\circ\text{C}$ to $+85^\circ\text{C}$ | | ± 0.5 | | dB |
| 2LO - 2RF Spur Rejection | 2 x 2 | $f_{RF} = 1850\text{MHz}$, $f_{LO} = 2150\text{MHz}$, $f_{SPUR} = 2000\text{MHz}$ | $P_{RF} = -10\text{dBm}$ | 83 | | dBc |
| | | | $P_{RF} = 0\text{dBm}$ | 73 | | |
| 3LO - 3RF Spur Rejection | 3 x 3 | $f_{RF} = 1850\text{MHz}$, $f_{LO} = 2150\text{MHz}$, $f_{SPUR} = 2050\text{MHz}$ | $P_{RF} = -10\text{dBm}$ | 94 | | dBc |
| | | | $P_{RF} = 0\text{dBm}$ | 74 | | |
| RF Input Return Loss | RL_{RF} | LO on and IF terminated into a matched impedance | | 16.4 | | dB |
| LO Input Return Loss | RL_{LO} | RF and IF terminated into a matched impedance | | 25.2 | | dB |
| IF Output Impedance | Z_{IF} | Nominal differential impedance at the IC's IF outputs | | 50 | | Ω |
| IF Return Loss | RL_{IF} | RF terminated into 50Ω , LO driven by 50Ω source, IF transformed to single-ended 50Ω using external components shown in the <i>Typical Application Circuit</i> | | 17 | | dB |
| RF-to-IF Isolation | | $P_{LO} = +3\text{dBm}$ | | 48.7 | | dB |
| LO Leakage at RF Port | | $P_{LO} = +3\text{dBm}$ | | -28.8 | | dBm |
| 2LO Leakage at RF Port | | $P_{LO} = +3\text{dBm}$ | | -35.3 | | dBm |
| LO Leakage at IF Port | | $P_{LO} = +3\text{dBm}$ | | -20.8 | | dBm |

SiGe High-Linearity, 1600MHz to 3900MHz Upconversion/Downconversion Mixer with LO Buffer

5.0V Supply, RF = 1650MHz to 2250MHz, LOW-SIDE LO INJECTION AC ELECTRICAL CHARACTERISTICS (DOWNCONVERTER OPERATION)

(*Typical Application Circuit* with tuning elements outlined in [Table 1](#). Typical values are for $T_C = +25^\circ\text{C}$, $V_{CC} = 5.0\text{V}$, $P_{RF} = 0\text{dBm}$, $P_{LO} = 0\text{dBm}$, $f_{RF} = 1850\text{MHz}$, $f_{LO} = 1550\text{MHz}$, $f_{IF} = 300\text{MHz}$, unless otherwise noted.)

| PARAMETER | SYMBOL | CONDITIONS | MIN | TYP | MAX | UNITS |
|---|--------------|---|--------------------------|-------------|-----|----------------------|
| Small-Signal Conversion Loss | L_C | | | 8.5 | | dB |
| Loss Variation vs. Frequency | ΔL_C | $f_{RF} = 1650\text{MHz}$ to 1850MHz , any 100MHz band | | ± 0.35 | | dB |
| | | $f_{RF} = 1850\text{MHz}$ to 2250MHz , any 100MHz band | | ± 0.075 | | |
| | | $f_{RF} = 1650\text{MHz}$ to 1850MHz , any 200MHz band | | ± 0.7 | | |
| | | $f_{RF} = 1850\text{MHz}$ to 2250MHz , any 200MHz band | | ± 0.15 | | |
| Conversion Loss Temperature Coefficient | TC_{CL} | $T_C = -40^\circ\text{C}$ to $+85^\circ\text{C}$ | | 0.0095 | | dB/ $^\circ\text{C}$ |
| Single Sideband Noise Figure | NF_{SSB} | No blockers present | | 8.95 | | dB |
| Noise Figure Temperature Coefficient | TC_{NF} | Single sideband, no blockers present, $T_C = -40^\circ\text{C}$ to $+85^\circ\text{C}$ | | 0.024 | | dB/ $^\circ\text{C}$ |
| Input 1dB Compression Point | IP_{1dB} | (Note 10) | | 17.2 | | dBm |
| Third-Order Input Intercept Point | $IIP3$ | $f_{RF1} = 1850\text{MHz}$, $f_{RF2} = 1851\text{MHz}$, $P_{RF1} = P_{RF2} = 0\text{dBm}$ | | 26.7 | | dBm |
| IIP3 Variation with T_C | | $f_{RF1} = 1850\text{MHz}$, $f_{RF2} = 1851\text{MHz}$, $P_{RF1} = P_{RF2} = 0\text{dBm}$, $T_C = -40^\circ\text{C}$ to $+85^\circ\text{C}$ | | ± 0.5 | | dB |
| 2RF - 2LO Spur Rejection | 2 x 2 | $f_{RF} = 1850\text{MHz}$, $f_{LO} = 1550\text{MHz}$, $f_{SPUR} = 1700\text{MHz}$ | $P_{RF} = -10\text{dBm}$ | | 71 | dBc |
| | | | $P_{RF} = 0\text{dBm}$ | | 61 | |
| 3RF - 3LO Spur Rejection | 3 x 3 | $f_{RF} = 1850\text{MHz}$, $f_{LO} = 1550\text{MHz}$, $f_{SPUR} = 1650\text{MHz}$ | $P_{RF} = -10\text{dBm}$ | | 83 | dBc |
| | | | $P_{RF} = 0\text{dBm}$ | | 63 | |
| RF Input Return Loss | RL_{RF} | LO on and IF terminated into a matched impedance | | 12.4 | | dB |
| LO Input Return Loss | RL_{LO} | RF and IF terminated into a matched impedance | | 17.3 | | dB |
| IF Output Impedance | Z_{IF} | Nominal differential impedance at the IC's IF outputs | | 50 | | Ω |
| IF Return Loss | RL_{IF} | RF terminated into 50Ω , LO driven by 50Ω source, IF transformed to single-ended 50Ω using external components shown in the <i>Typical Application Circuit</i> | | 19.3 | | dB |
| RF-to-IF Isolation | | $P_{LO} = +3\text{dBm}$ | | 44.6 | | dB |
| LO Leakage at RF Port | | $P_{LO} = +3\text{dBm}$ | | -29.5 | | dBm |
| 2LO Leakage at RF Port | | $P_{LO} = +3\text{dBm}$ | | -29.5 | | dBm |
| LO Leakage at IF Port | | $P_{LO} = +3\text{dBm}$ | | -29.7 | | dBm |

SiGe High-Linearity, 1600MHz to 3900MHz Upconversion/Downconversion Mixer with LO Buffer

5.0V Supply, RF = 2000MHz to 2900MHz, HIGH-SIDE LO INJECTION AC ELECTRICAL CHARACTERISTICS (UPCONVERTER OPERATION)

(*Typical Application Circuit* with tuning elements outlined in [Table 2](#). Typical values are for $T_C = +25^\circ\text{C}$, $V_{CC} = 5.0\text{V}$, $P_{IF} = 0\text{dBm}$, $P_{LO} = 0\text{dBm}$, $f_{RF} = 2600\text{MHz}$, $f_{LO} = 2900\text{MHz}$, $f_{IF} = 300\text{MHz}$, unless otherwise noted.)

| PARAMETER | SYMBOL | CONDITIONS | MIN | TYP | MAX | UNITS |
|---|--------------|--|-----|------------|-----|----------------------|
| Conversion Loss | L_C | | | 7.3 | | dB |
| Conversion Loss Variation vs. Frequency | ΔL_C | $f_{RF} = 2010\text{MHz to } 2025\text{MHz}$ | | ± 0.05 | | dB |
| | | $f_{RF} = 2305\text{MHz to } 2360\text{MHz}$ | | ± 0.05 | | |
| | | $f_{RF} = 2500\text{MHz to } 2570\text{MHz}$ | | ± 0.05 | | |
| | | $f_{RF} = 2570\text{MHz to } 2620\text{MHz}$ | | ± 0.05 | | |
| | | $f_{RF} = 2500\text{MHz to } 2690\text{MHz}$ | | ± 0.15 | | |
| | | $f_{RF} = 2700\text{MHz to } 2900\text{MHz}$ | | ± 0.2 | | |
| Conversion Loss Temperature Coefficient | TC_{CL} | $T_C = -40^\circ\text{C to } +85^\circ\text{C}$ | | 0.007 | | dB/ $^\circ\text{C}$ |
| Input 1dB Compression Point | IP_{1dB} | (Note 10) | | 22 | | dBm |
| Input Third-Order Intercept Point | IIP3 | $f_{IF1} = 300\text{MHz}$, $f_{IF2} = 301\text{MHz}$, $P_{IF} = 0\text{dBm/ tone}$ | | 32.8 | | dBm |
| IIP3 Variation with T_C | IIP3 | $f_{IF1} = 300\text{MHz}$, $f_{IF2} = 301\text{MHz}$, $P_{IF} = 0\text{dBm/ tone}$, $T_C = -40^\circ\text{C to } +85^\circ\text{C}$ | | ± 0.5 | | dB |
| LO \pm 2IF Spur | | LO - 2IF | | 61 | | dBc |
| | | LO + 2IF | | 62 | | |
| LO \pm 3IF Spur | | LO - 3IF | | 72 | | dBc |
| | | LO + 3IF | | 85 | | |
| Output Noise Floor | | $P_{OUT} = 0\text{dBm}$ (Note 9) | | -163 | | dBm/Hz |

SiGe High-Linearity, 1600MHz to 3900MHz Upconversion/Downconversion Mixer with LO Buffer

3.3V Supply, RF = 2000MHz to 2900MHz, HIGH-SIDE LO INJECTION AC ELECTRICAL CHARACTERISTICS (UPCONVERTER OPERATION)

([Typical Application Circuit](#) with tuning elements outlined in [Table 2](#). Typical values are for $T_C = +25^\circ\text{C}$, $V_{CC} = 3.3\text{V}$, $P_{IF} = 0\text{dBm}$, $P_{LO} = 0\text{dBm}$, $f_{RF} = 2600\text{MHz}$, $f_{LO} = 2900\text{MHz}$, $f_{IF} = 300\text{MHz}$, unless otherwise noted.)

| PARAMETER | SYMBOL | CONDITIONS | MIN | TYP | MAX | UNITS |
|---|--------------|--|-----|------------|-----|----------------------|
| Conversion Loss | L_C | | | 7.3 | | dB |
| Conversion Loss Variation vs. Frequency | ΔL_C | $f_{RF} = 2000\text{MHz to } 2900\text{MHz}$, any 100MHz band | | ± 0.25 | | dB |
| Conversion Loss Temperature Coefficient | TC_{CL} | $T_C = -40^\circ\text{C to } +85^\circ\text{C}$ | | 0.008 | | dB/ $^\circ\text{C}$ |
| Input 1dB Compression Point | IP_{1dB} | (Note 10) | | 20.5 | | dBm |
| Input Third-Order Intercept Point | IIP3 | $f_{IF1} = 300\text{MHz}$, $f_{IF2} = 301\text{MHz}$, $P_{IF} = 0\text{dBm/ tone}$ | | 30 | | dBm |
| IIP3 Variation with T_C | IIP3 | $f_{IF1} = 300\text{MHz}$, $f_{IF2} = 301\text{MHz}$, $P_{IF} = 0\text{dBm/ tone}$, $T_C = -40^\circ\text{C to } +85^\circ\text{C}$ | | ± 0.6 | | dB |
| LO \pm 2IF Spur | | LO - 2IF | | 60 | | dBc |
| | | LO + 2IF | | 64 | | |
| LO \pm 3IF Spur | | LO - 3IF | | 68 | | dBc |
| | | LO + 3IF | | 80 | | |
| Output Noise Floor | | $P_{OUT} = 0\text{dBm}$ (Note 9) | | -160 | | dBm/Hz |

Note 5: Not production tested.

Note 6: Operation outside this range is possible, but with degraded performance of some parameters. See the [Typical Operating Characteristics](#).

Note 7: All limits reflect losses of external components, including a 0.5dB loss at $f_{IF} = 300\text{MHz}$ due to the 1:1 impedance transformer. Output measurements were taken at IF outputs of the [Typical Application Circuit](#).

Note 8: 100% production tested for functional performance.

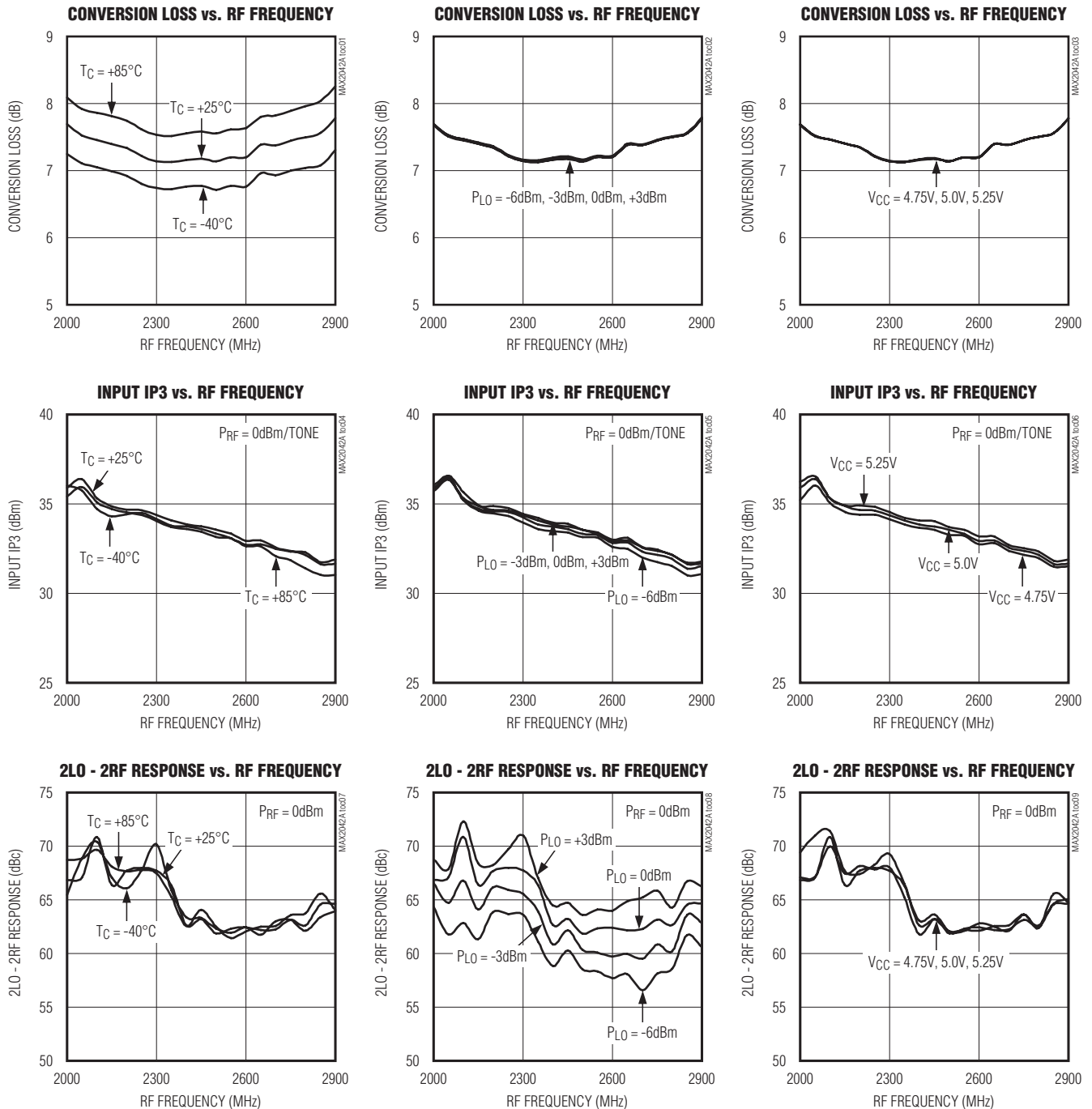
Note 9: Measured with external LO source noise filtered so that the noise floor is -174dBm/Hz at 100MHz offset. This specification reflects the effects of all SNR degradations in the mixer including the LO noise, as defined in Application Note 2021: [Specifications and Measurement of Local Oscillator Noise in Integrated Circuit Base Station Mixers](#).

Note 10: Maximum reliable continuous input power applied to the RF or IF port of this device is +12dBm from a 50 Ω source.

SiGe High-Linearity, 1600MHz to 3900MHz Upconversion/Downconversion Mixer with LO Buffer

Typical Operating Characteristics

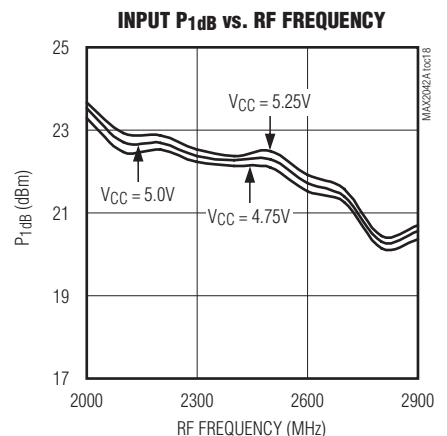
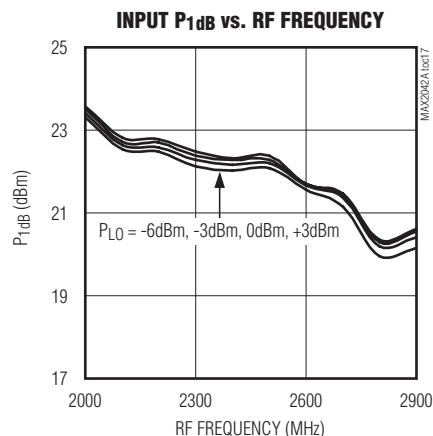
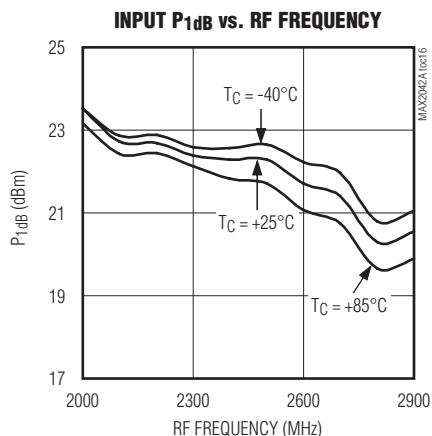
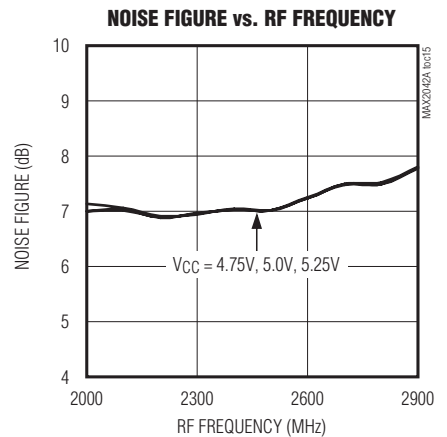
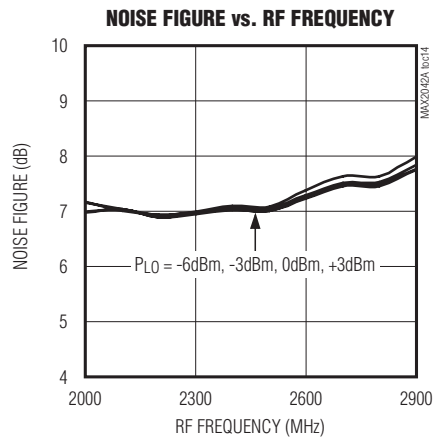
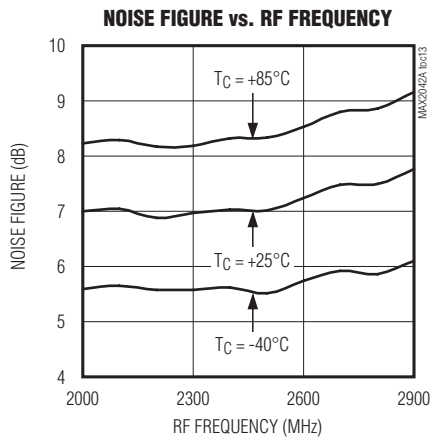
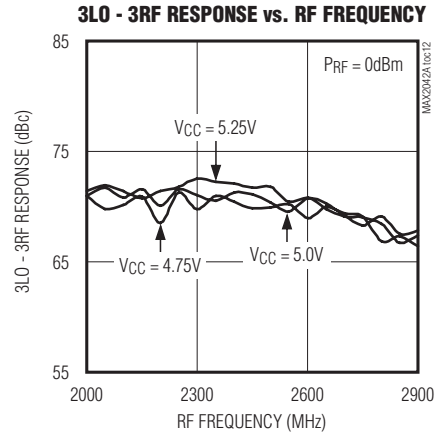
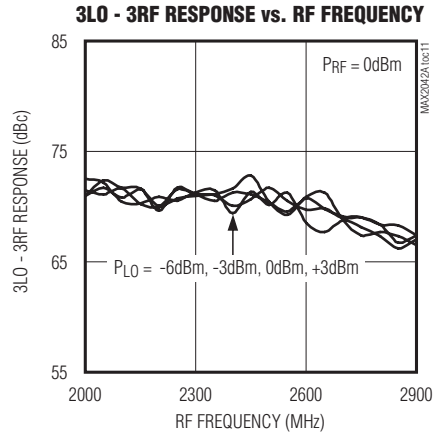
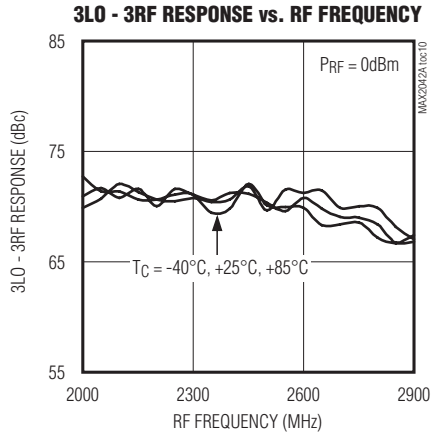
(Typical Application Circuit with tuning elements outlined in Table 1, $V_{CC} = 5.0V$, $f_{RF} = 2000MHz$ to $2900MHz$, LO is high-side injected for a 300MHz IF, $P_{RF} = 0dBm$, $P_{LO} = 0dBm$, $T_C = +25^\circ C$, unless otherwise noted.)



SiGe High-Linearity, 1600MHz to 3900MHz Upconversion/Downconversion Mixer with LO Buffer

Typical Operating Characteristics (continued)

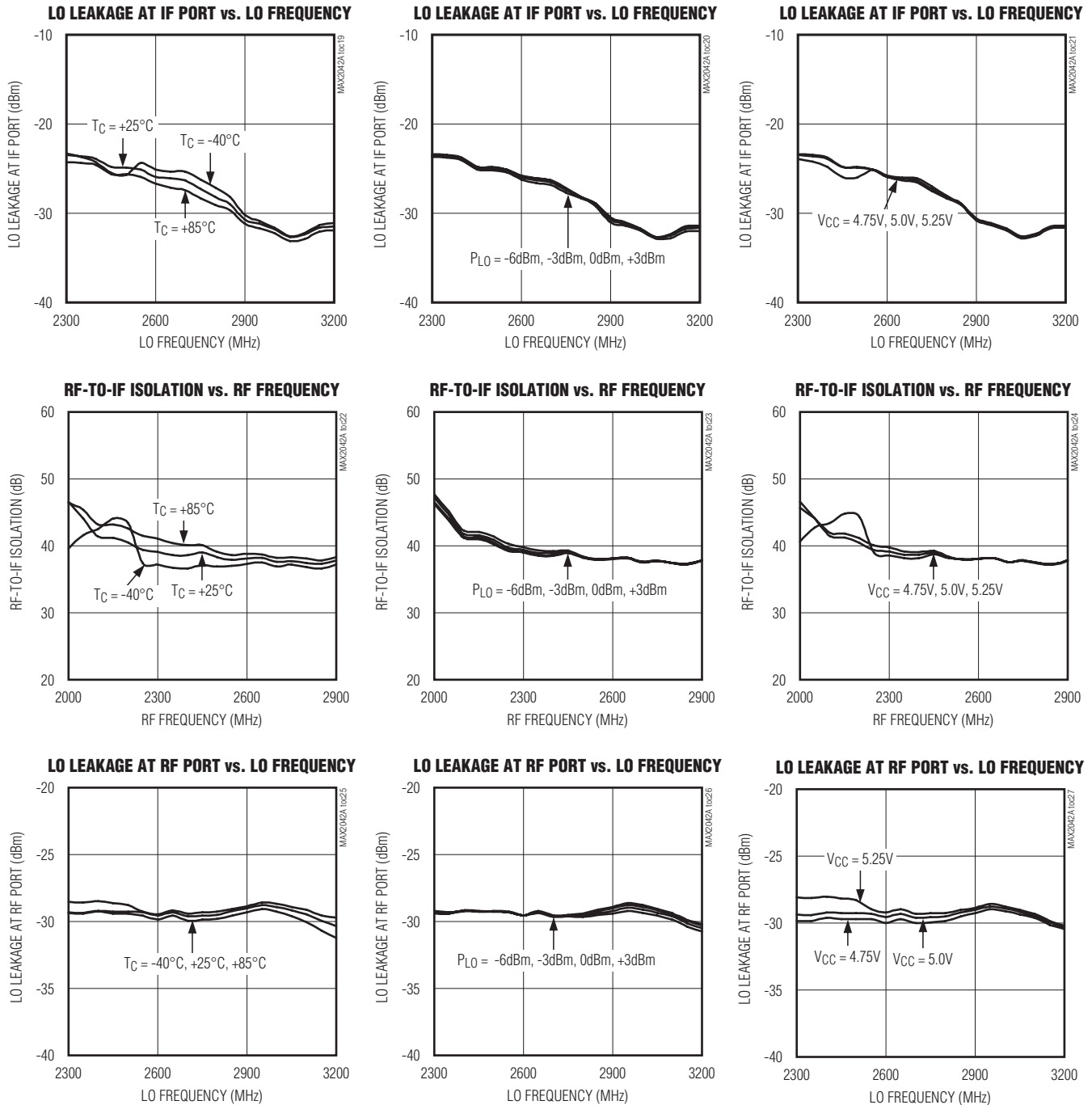
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SiGe High-Linearity, 1600MHz to 3900MHz Upconversion/Downconversion Mixer with LO Buffer

Typical Operating Characteristics (continued)

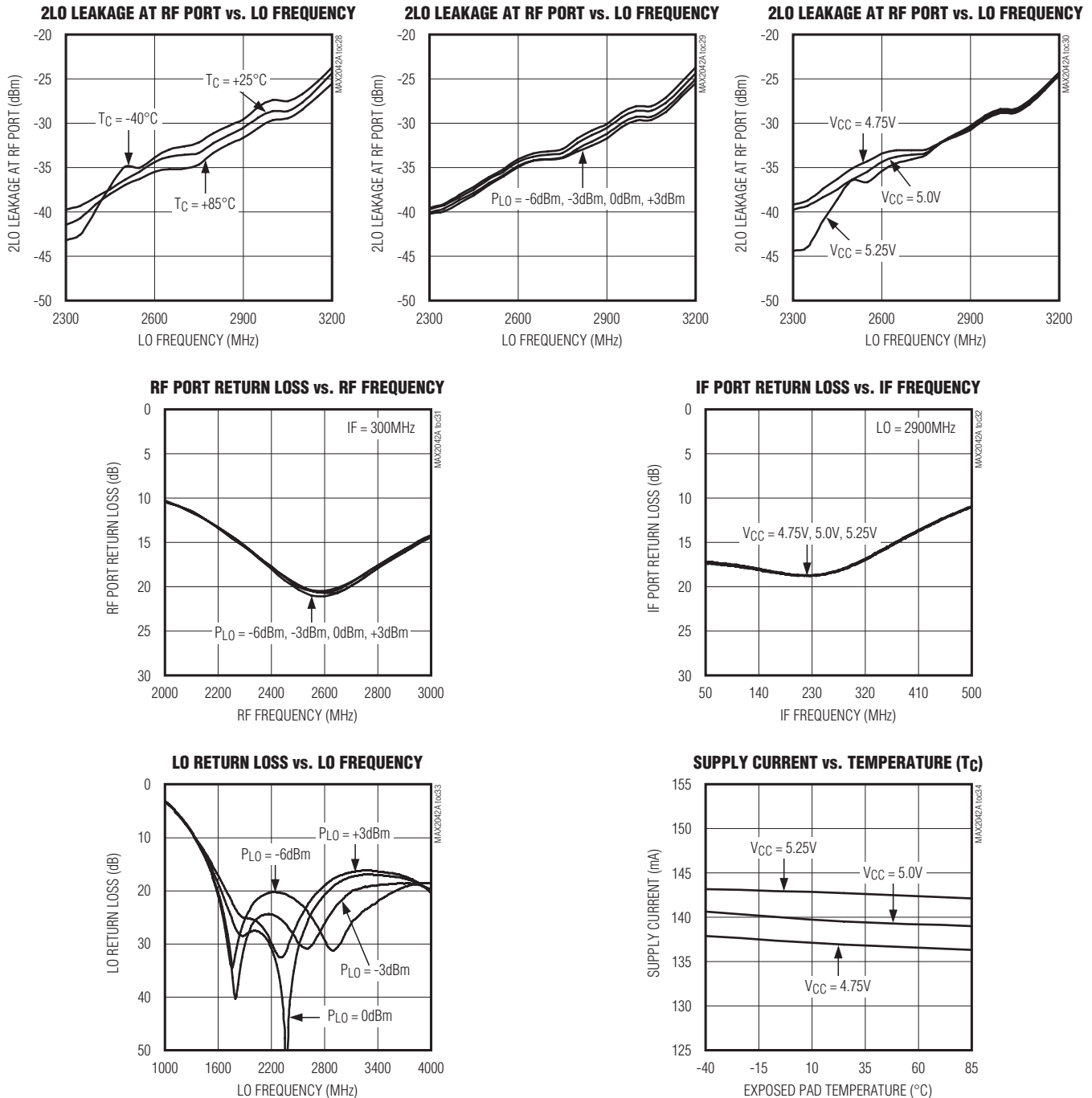
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SiGe High-Linearity, 1600MHz to 3900MHz Upconversion/Downconversion Mixer with LO Buffer

Typical Operating Characteristics (continued)

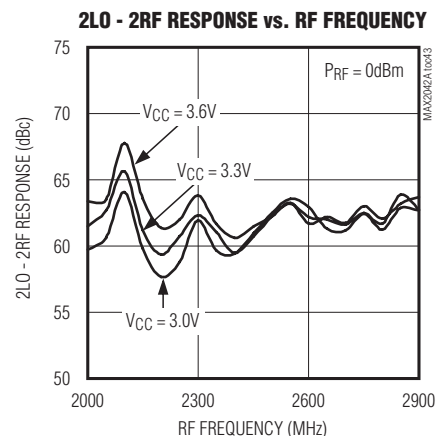
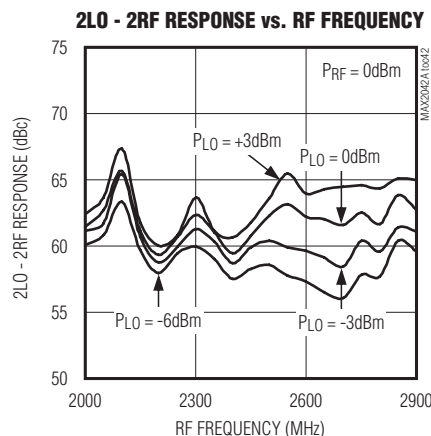
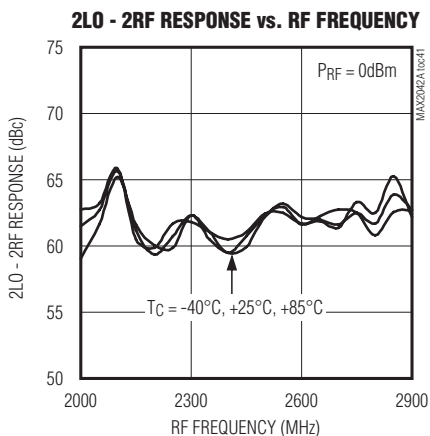
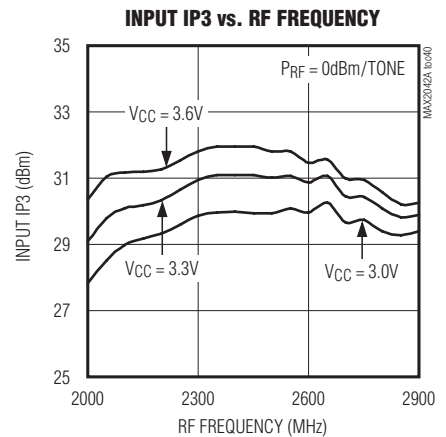
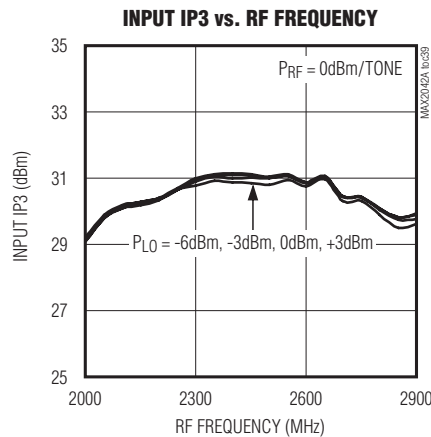
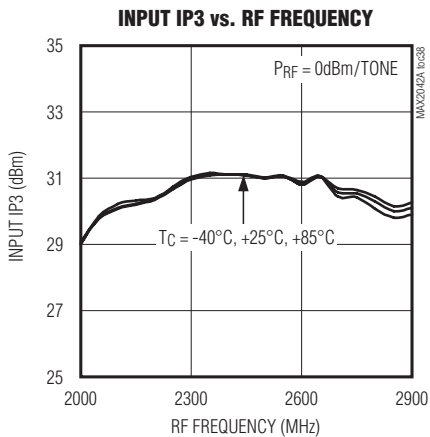
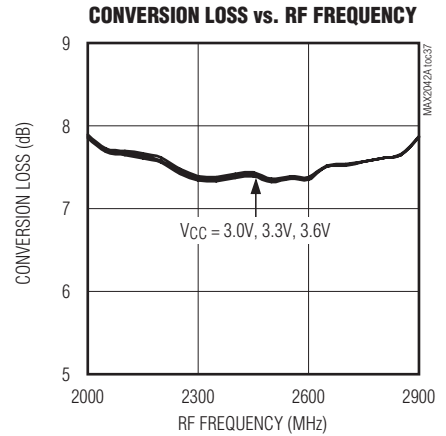
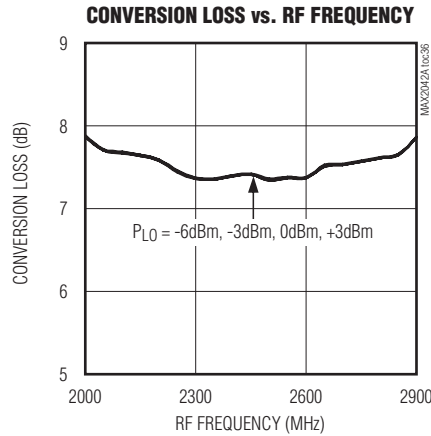
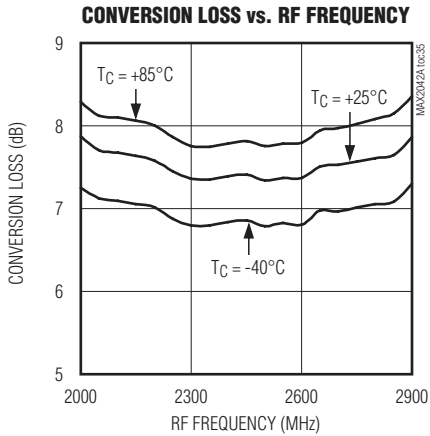
(Typical Application Circuit with tuning elements outlined in Table 1, $V_{CC} = 5.0V$, $f_{RF} = 2000MHz$ to $2900MHz$, LO is high-side injected for a 300MHz IF, $P_{RF} = 0dBm$, $P_{LO} = 0dBm$, $T_C = +25^\circ C$, unless otherwise noted.)



SiGe High-Linearity, 1600MHz to 3900MHz Upconversion/Downconversion Mixer with LO Buffer

Typical Operating Characteristics (continued)

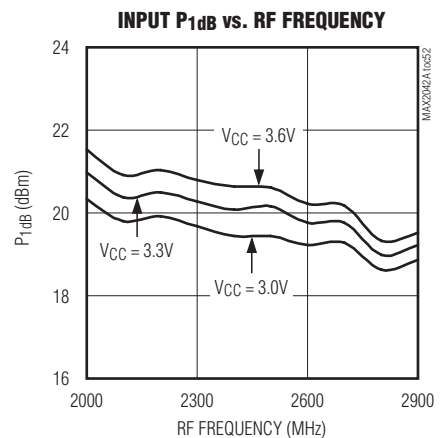
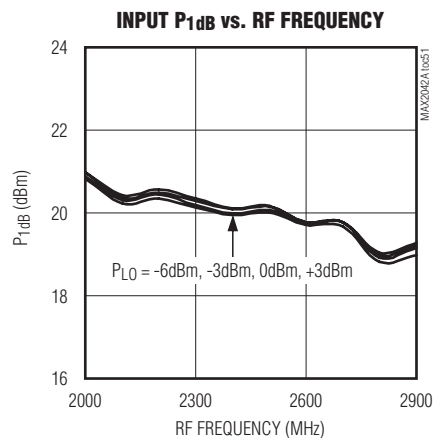
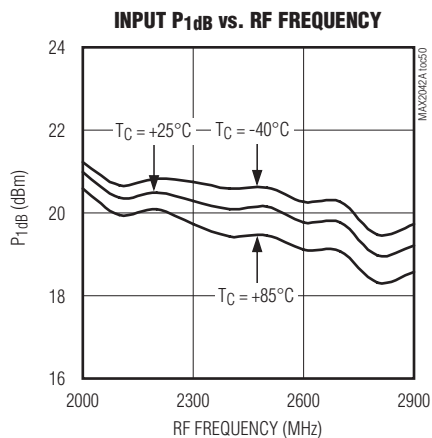
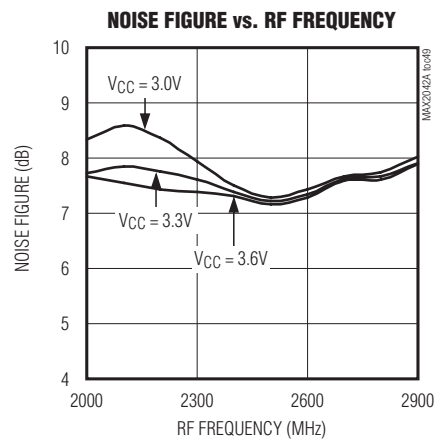
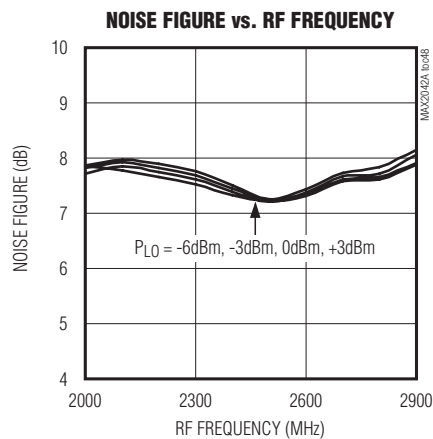
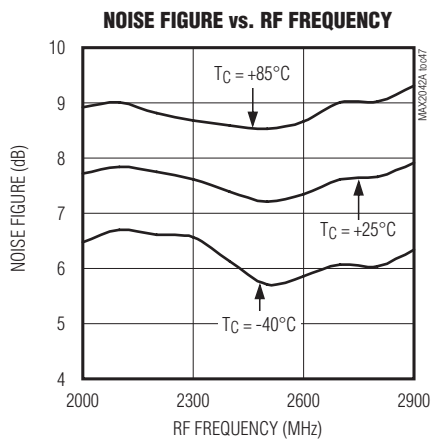
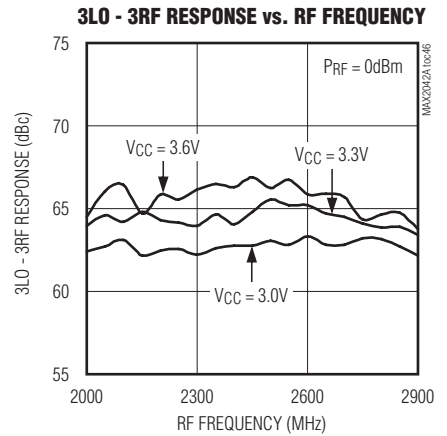
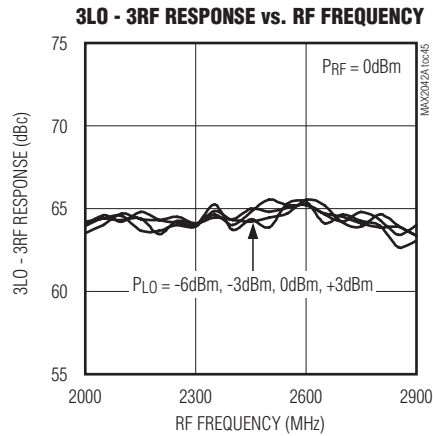
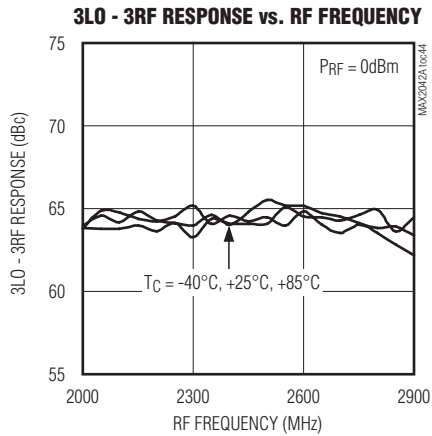
(Typical Application Circuit with tuning elements outlined in Table 1, $V_{CC} = 3.3V$, $f_{RF} = 2000MHz$ to $2900MHz$, LO is high-side injected for a 300MHz IF, $P_{RF} = 0dBm$, $P_{LO} = 0dBm$, $T_C = +25^\circ C$, unless otherwise noted.)



SiGe High-Linearity, 1600MHz to 3900MHz Upconversion/Downconversion Mixer with LO Buffer

Typical Operating Characteristics (continued)

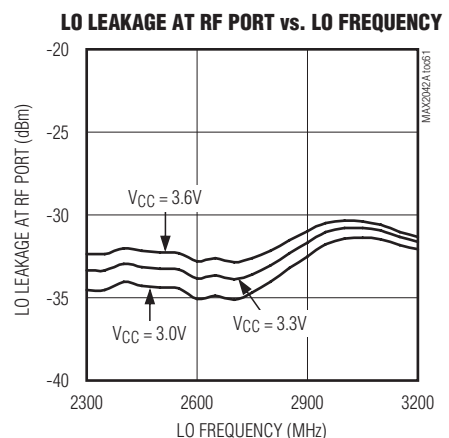
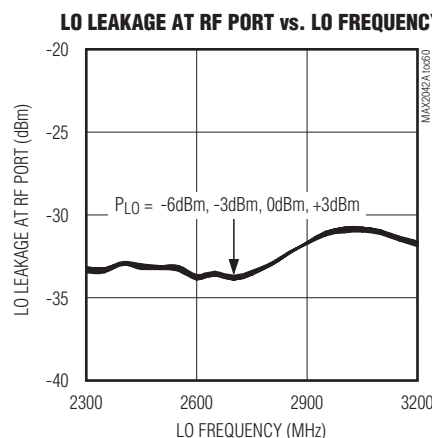
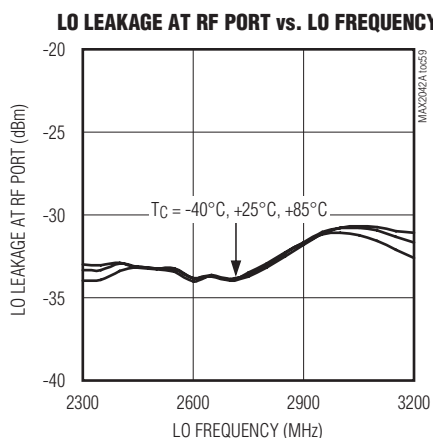
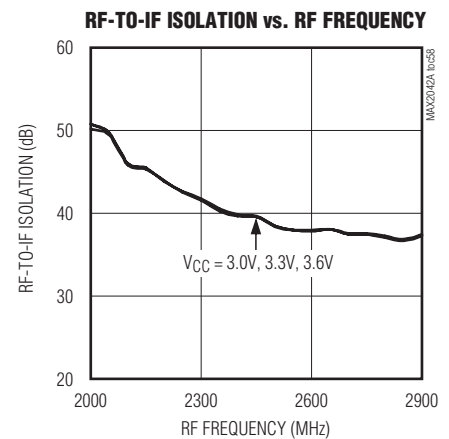
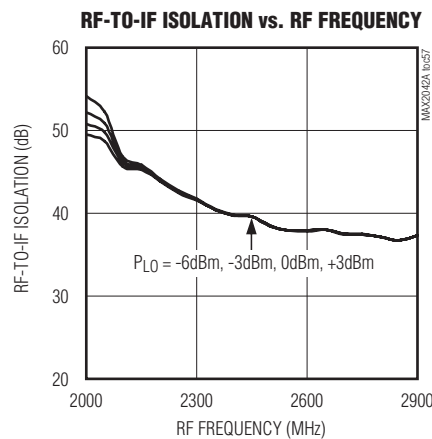
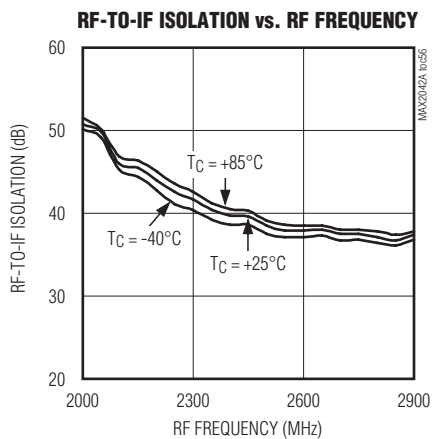
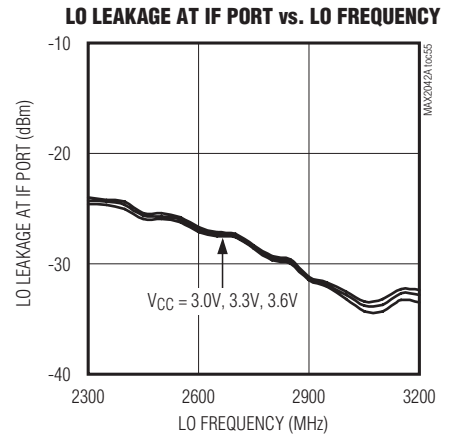
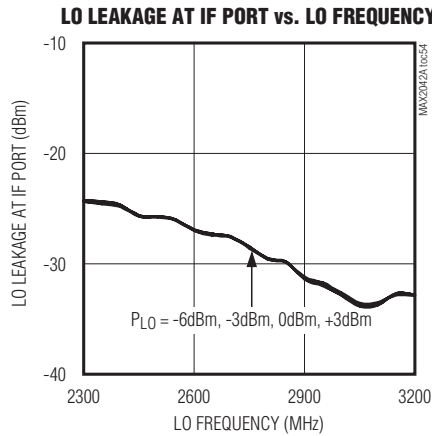
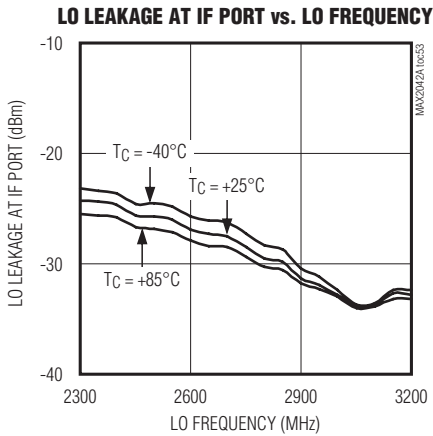
(Typical Application Circuit with tuning elements outlined in Table 1, $V_{CC} = 3.3V$, $f_{RF} = 2000MHz$ to $2900MHz$, LO is high-side injected for a 300MHz IF, $P_{RF} = 0dBm$, $P_{LO} = 0dBm$, $T_C = +25^\circ C$, unless otherwise noted.)



SiGe High-Linearity, 1600MHz to 3900MHz Upconversion/Downconversion Mixer with LO Buffer

Typical Operating Characteristics (continued)

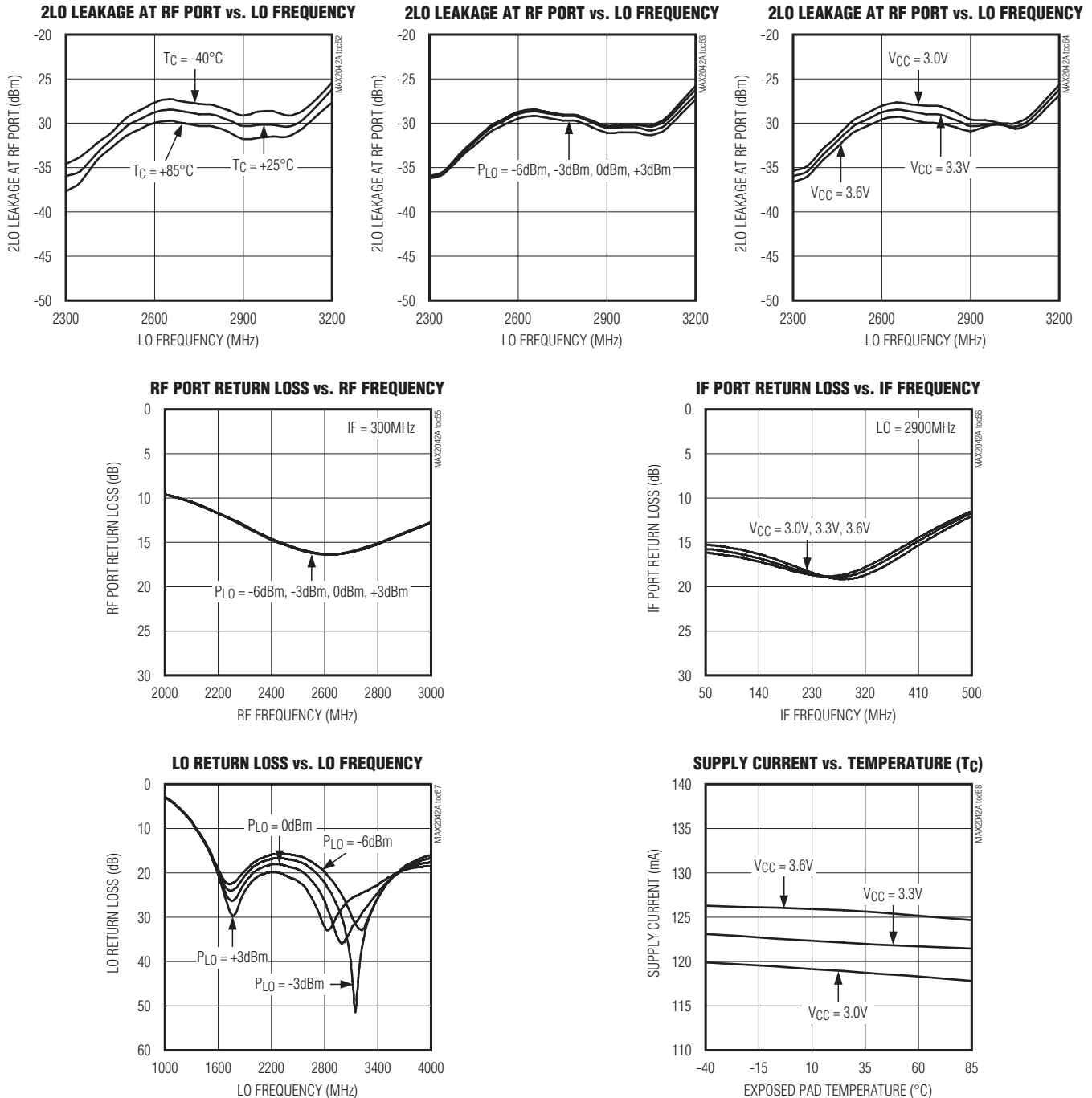
(Typical Application Circuit with tuning elements outlined in Table 1, $V_{CC} = 3.3V$, $f_{RF} = 2000MHz$ to $2900MHz$, LO is high-side injected for a 300MHz IF, $P_{RF} = 0dBm$, $P_{LO} = 0dBm$, $T_C = +25^\circ C$, unless otherwise noted.)



SiGe High-Linearity, 1600MHz to 3900MHz Upconversion/Downconversion Mixer with LO Buffer

Typical Operating Characteristics (continued)

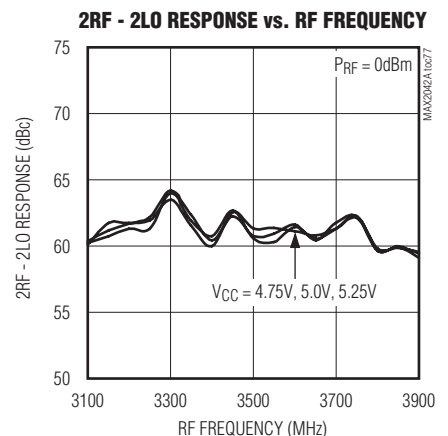
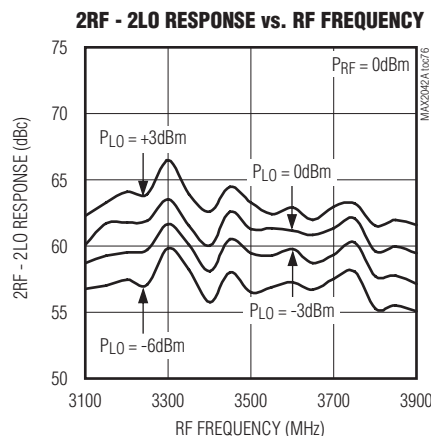
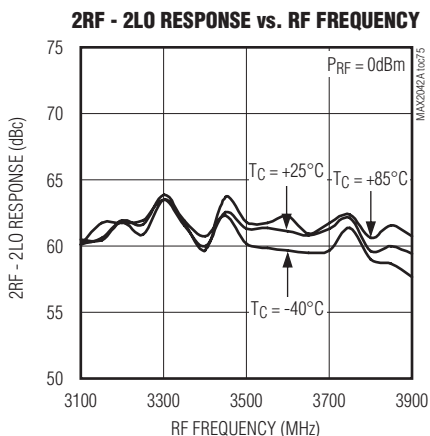
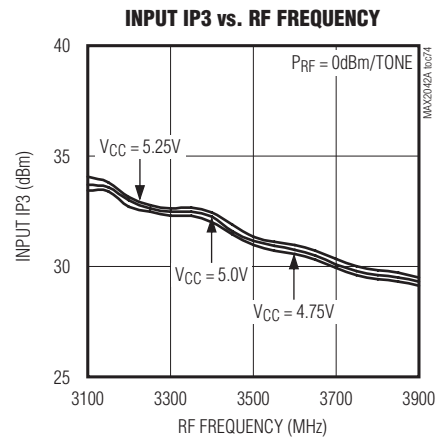
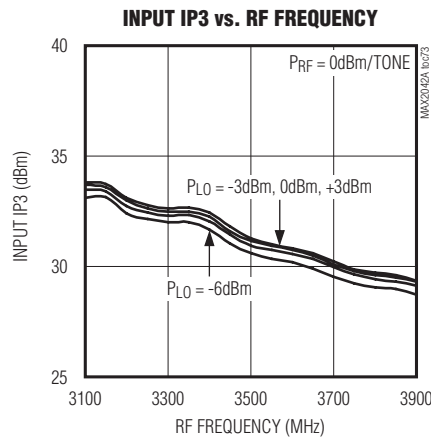
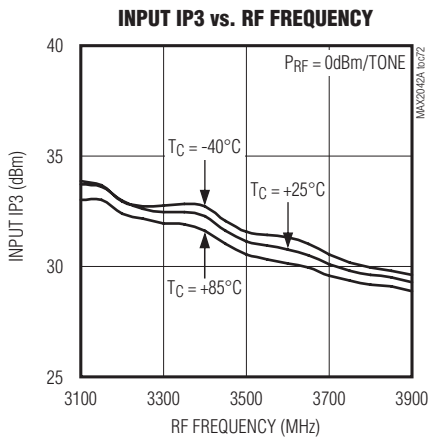
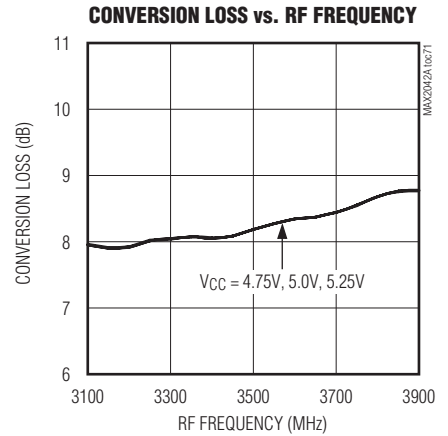
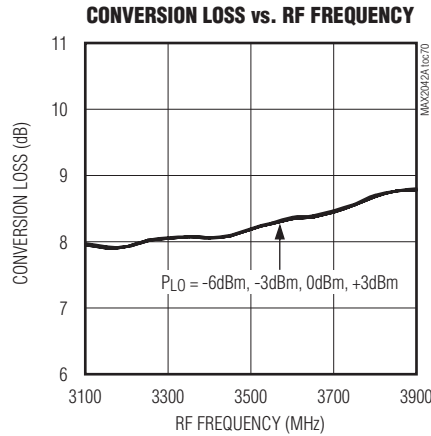
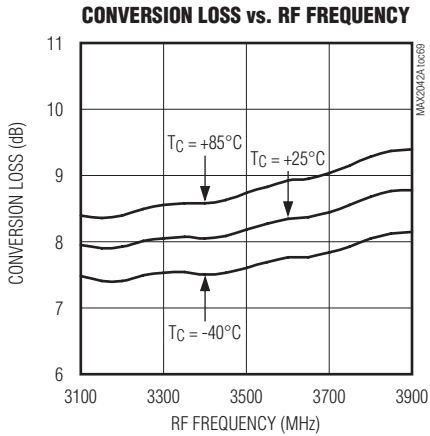
(Typical Application Circuit with tuning elements outlined in Table 1, $V_{CC} = 3.3V$, $f_{RF} = 2000MHz$ to $2900MHz$, LO is high-side injected for a 300MHz IF, $P_{RF} = 0dBm$, $P_{LO} = 0dBm$, $T_C = +25^\circ C$, unless otherwise noted.)



SiGe High-Linearity, 1600MHz to 3900MHz Upconversion/Downconversion Mixer with LO Buffer

Typical Operating Characteristics (continued)

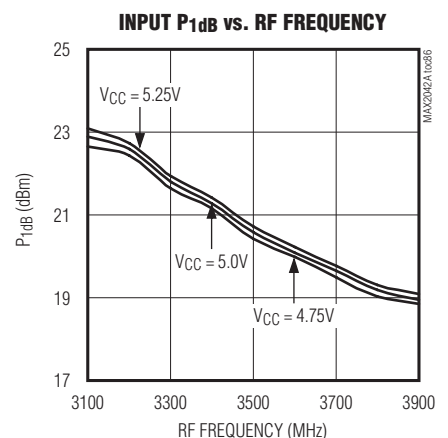
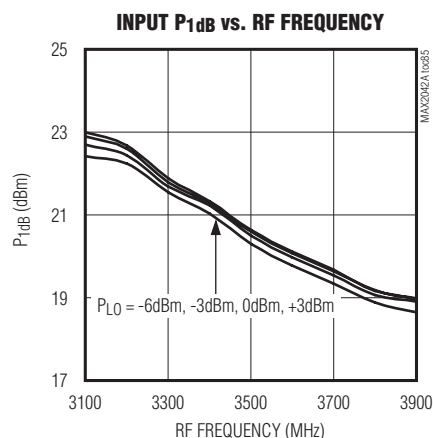
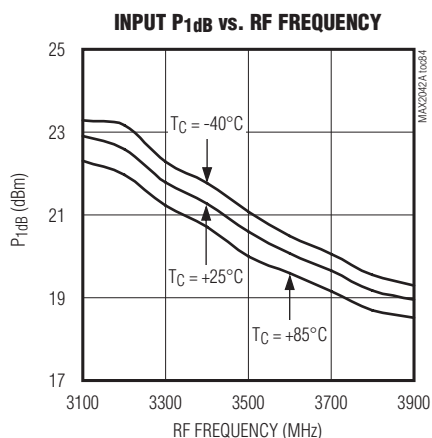
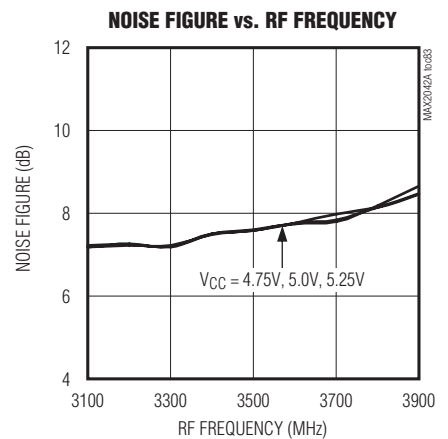
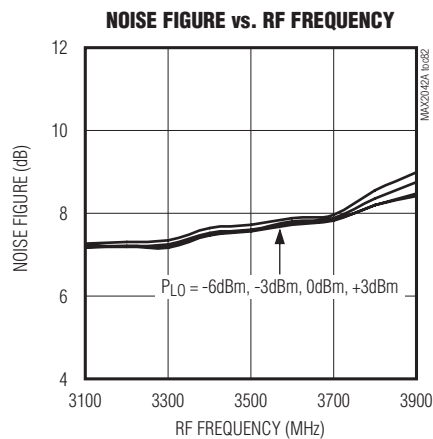
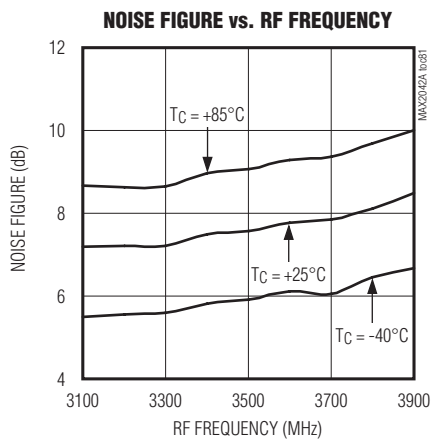
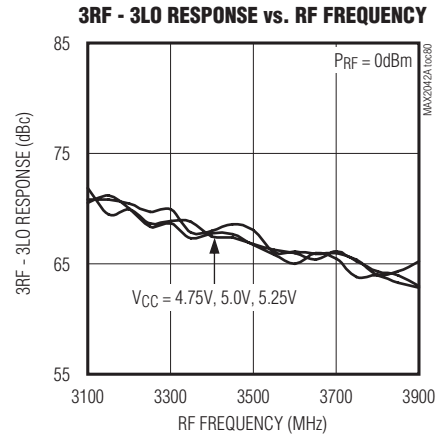
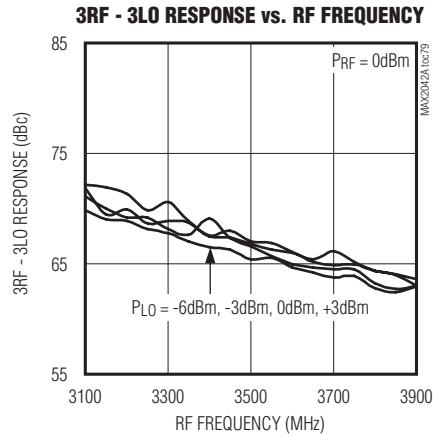
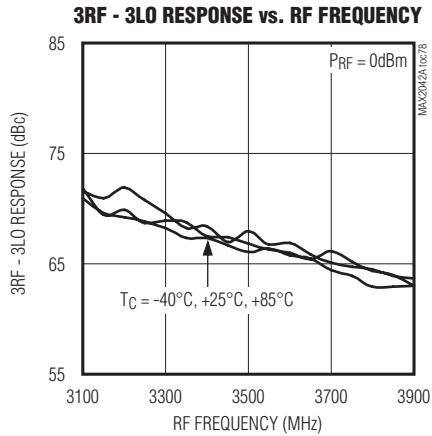
(Typical Application Circuit with tuning elements outlined in Table 1, $V_{CC} = 5.0V$, $f_{RF} = 3100MHz$ to $3900MHz$, LO is low-side injected for a 300MHz IF, $P_{RF} = 0dBm$, $P_{LO} = 0dBm$, $T_C = +25^\circ C$, unless otherwise noted.)



SiGe High-Linearity, 1600MHz to 3900MHz Upconversion/Downconversion Mixer with LO Buffer

Typical Operating Characteristics (continued)

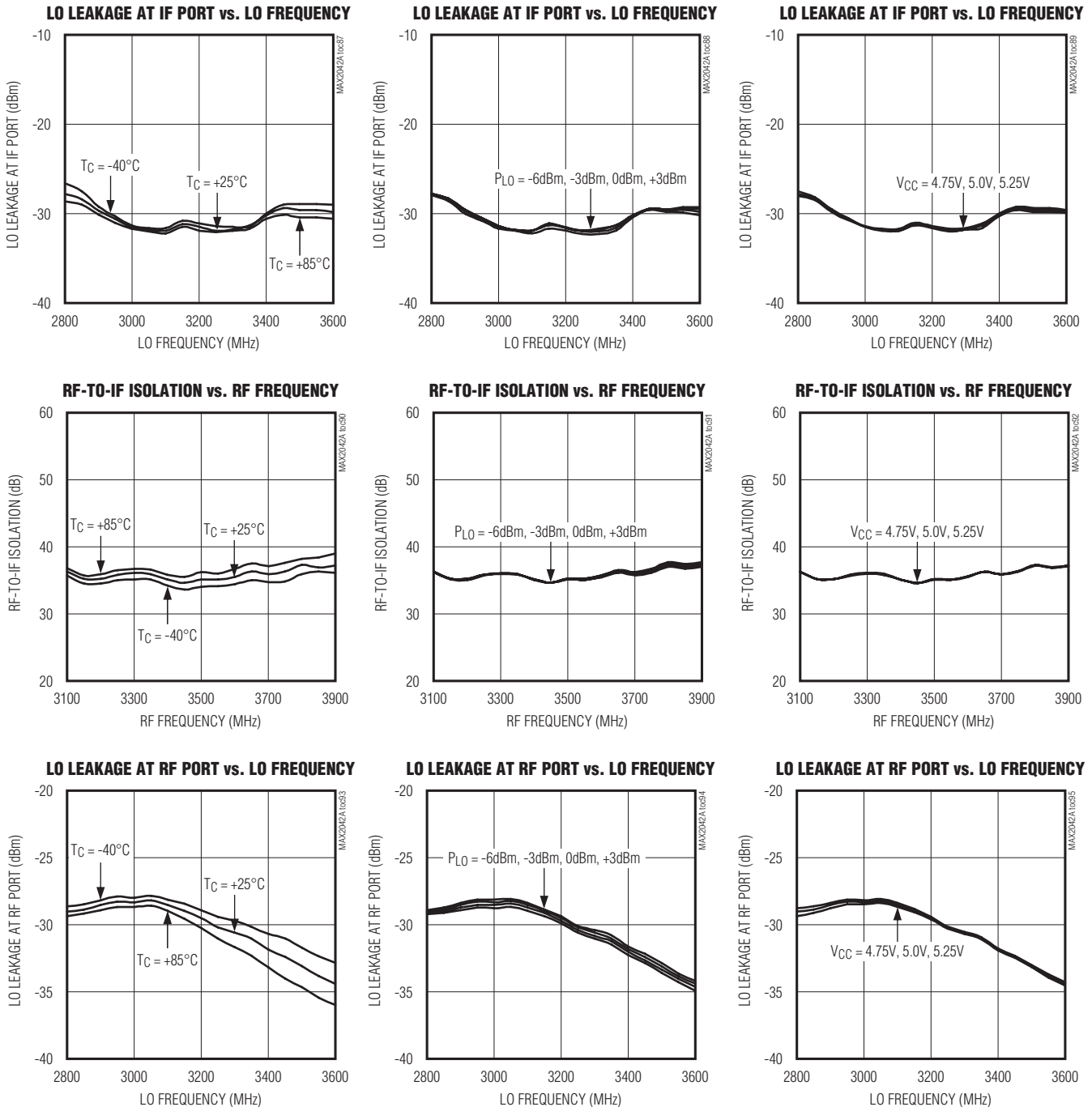
(Typical Application Circuit with tuning elements outlined in Table 1, $V_{CC} = 5.0V$, $f_{RF} = 3100MHz$ to $3900MHz$, LO is low-side injected for a 300MHz IF, $P_{RF} = 0dBm$, $P_{LO} = 0dBm$, $T_C = +25^\circ C$, unless otherwise noted.)



SiGe High-Linearity, 1600MHz to 3900MHz Upconversion/Downconversion Mixer with LO Buffer

Typical Operating Characteristics (continued)

(Typical Application Circuit with tuning elements outlined in Table 1, $V_{CC} = 5.0V$, $f_{RF} = 3100MHz$ to $3900MHz$, LO is low-side injected for a 300MHz IF, $P_{RF} = 0dBm$, $P_{LO} = 0dBm$, $T_C = +25^\circ C$, unless otherwise noted.)

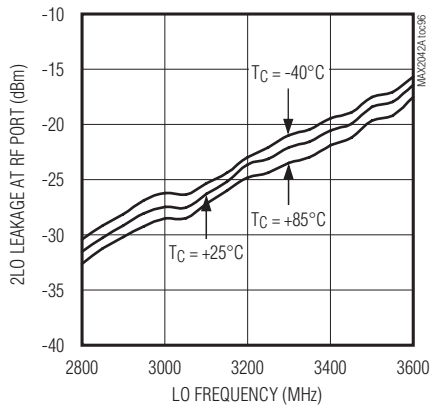


SiGe High-Linearity, 1600MHz to 3900MHz Upconversion/Downconversion Mixer with LO Buffer

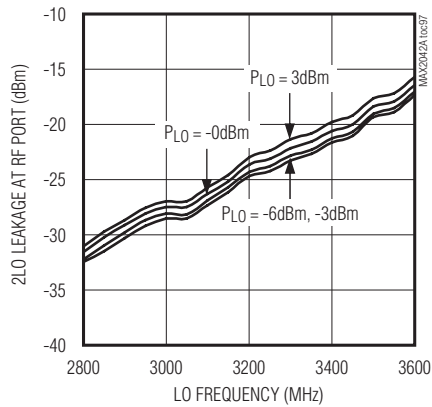
Typical Operating Characteristics (continued)

(Typical Application Circuit with tuning elements outlined in Table 1, $V_{CC} = 5.0V$, $f_{RF} = 3100MHz$ to $3900MHz$, LO is low-side injected for a 300MHz IF, $P_{RF} = 0dBm$, $P_{LO} = 0dBm$, $T_C = +25^\circ C$, unless otherwise noted.)

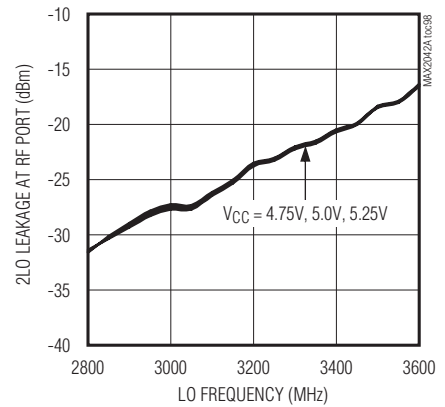
2LO LEAKAGE AT RF PORT vs. LO FREQUENCY



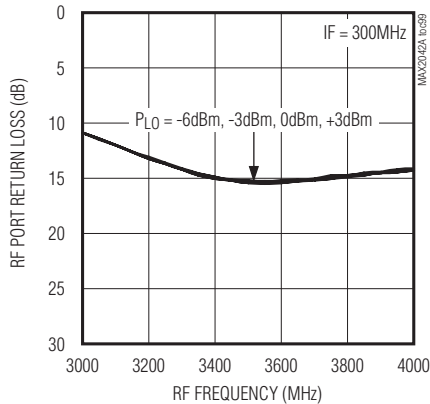
2LO LEAKAGE AT RF PORT vs. LO FREQUENCY



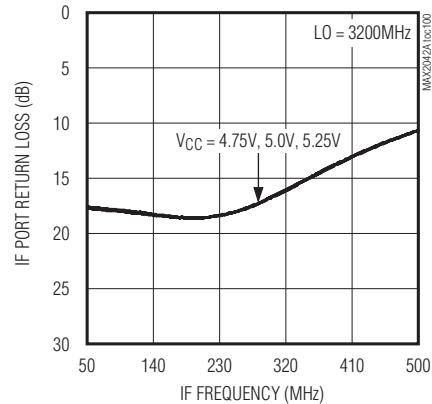
2LO LEAKAGE AT RF PORT vs. LO FREQUENCY



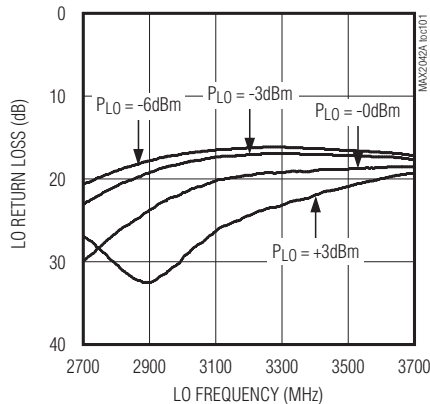
RF PORT RETURN LOSS vs. RF FREQUENCY



IF PORT RETURN LOSS vs. IF FREQUENCY



LO RETURN LOSS vs. LO FREQUENCY



SUPPLY CURRENT vs. TEMPERATURE (T_C)

